

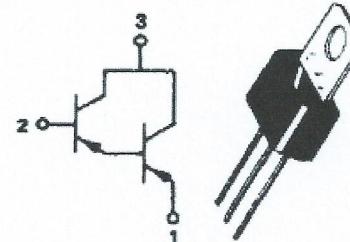
# MPS-U95 (SILICON)

## PNP SILICON DARLINGTON AMPLIFIER TRANSISTOR

...designed for amplifier and driver applications.

- High DC Current Gain –  
 $hFE = 25,000$  (Min) @  $I_C = 200$  mAdc  
 $15,000$  (Min) @  $I_C = 500$  mAdc
- Collector-Emitter Breakdown Voltage –  
 $BV_{CES} = 40$  Vdc (Min) @  $I_C = 100$   $\mu$ Adc
- Low Collector-Emitter Saturation Voltage –  
 $V_{CE(sat)} = 1.5$  Vdc @  $I_C = 1.0$  Adc
- Monolithic Construction for High Reliability
- Complement to NPN MPS-U45

## PNP SILICON DARLINGTON TRANSISTOR



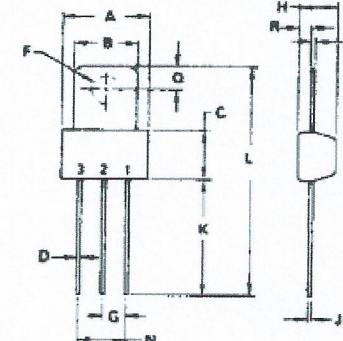
### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CES}$	40	Vdc
Collector-Base Voltage	$V_{CB}$	50	Vdc
Emitter-Base Voltage	$V_{EB}$	10	Vdc
Collector Current -Continuous	$I_C$	2.0	Adc
Total Power Dissipation @ $T_A = 25^\circ C$ Derate above $25^\circ C$	$P_D$	1.0 8.0	Watt mW/ $^\circ C$
Total Power Dissipation @ $T_C = 25^\circ C$ Derate above $25^\circ C$	$P_D$	10 80	Watts mW/ $^\circ C$
Operating and Storage Junction Temperature Range	$T_J, T_{Stg}$	-55 to +150	$^\circ C$

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	125	$^\circ C/W$
Thermal Resistance, Junction to Case	$R_{\theta JC(1)}$	12.5	$^\circ C/W$

(1)  $R_{\theta JC}$  is measured with the device soldered into a typical printed circuit board.



STYLE 1: PIN 1 Emitter 2 Base 3 Collector	MILLIMETERS		INCHES		
	DIM	MIN	MAX	MIN	MAX
A	9.14	9.53	0.360	0.376	
B	6.00	7.24	0.236	0.286	
C	5.41	5.88	0.213	0.223	
D	0.38	0.63	0.015	0.021	
F	3.18	3.33	0.125	0.131	
G	2.54	2.56	0.100	0.102	
H	3.94	4.19	0.155	0.165	
J	0.36	0.41	0.014	0.016	
K	12.07	12.78	0.475	0.500	
L	26.02	26.53	0.865	1.006	
M	1.00	1.02	0.039	0.040	
N	2.79	2.89	0.064	0.100	
R	1.14	1.40	0.045	0.056	

CASE 162-02

# MPS-U95 (SILICON)

ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>					
Collector-Emitter Breakdown Voltage ( $I_C = 100 \mu\text{Adc}, V_{BE} = 0$ )	$V_{CES}$	40	—	—	Vdc
Collector-Base Breakdown Voltage ( $I_C = 100 \mu\text{Adc}, I_E = 0$ )	$V_{CBO}$	50	—	—	Vdc
Emitter-Base Breakdown Voltage ( $I_E = 10 \mu\text{Adc}, I_C = 0$ )	$V_{EBO}$	10	—	—	Vdc
Collector Cutoff Current ( $V_{CB} = 30 \text{ Vdc}, I_E = 0$ )	$I_{CBO}$	—	—	100	nAdc
Emitter Cutoff Current ( $V_{EB} = 8.0 \text{ Vdc}, I_C = 0$ )	$I_{EBO}$	—	—	100	nAdc
<b>ON CHARACTERISTICS(1)</b>					
DC Current Gain ( $I_C = 200 \text{ mAdc}, V_{CE} = 5.0 \text{ Vdc}$ ) ( $I_C = 500 \text{ mAdc}, V_{CE} = 5.0 \text{ Vdc}$ ) ( $I_C = 1.0 \text{ Adc}, V_{CE} = 5.0 \text{ Vdc}$ )	$h_{FE}$	25,000 15,000 4,000	43,000 41,000 35,000	150,000 — —	—
Collector-Emitter Saturation Voltage ( $I_C = 1.0 \text{ Adc}, I_B = 2.0 \text{ mAdc}$ )	$V_{CE(\text{sat})}$	—	1.0	1.5	Vdc
Base-Emitter Saturation Voltage ( $I_C = 1.0 \text{ Adc}, I_B = 2.0 \text{ mAdc}$ )	$V_{BE(\text{sat})}$	—	1.85	2.0	Vdc
Base-Emitter On Voltage ( $I_C = 1.0 \text{ Adc}, V_{CE} = 5.0 \text{ Vdc}$ )	$V_{BE(\text{on})}$	—	1.7	2.0	Vdc
<b>DYNAMIC CHARACTERISTICS</b>					
Small-Signal Current Gain (1) ( $I_C = 200 \text{ mAdc}, V_{CE} = 5.0 \text{ Vdc}, f = 100 \text{ MHz}$ )	$ h_{fe} $	0.5	1.6	—	—
Collector-Base Capacitance ( $V_{CB} = 10 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz}$ )	$C_{cb}$	—	2.5	12	pF

(1)Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .